

	L #	Hits	Search Text	DBs	Time Stamp
1	L1	2952	(438/106).CCLS.	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:26
2	L2	1127	1 and (insulation or insulating or insulated)	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27
3	L3	830	2 and (opening or via or hole)	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27

	L #	Hits	Search Text	DBs	Time Stamp
7	L7	54	6 and ((@ad<"20030224") or (@rlad<"20030224"))	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:28
8	L8	49	7 and (bond or bonding or laminate or laminating)	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27
9	L9	135	(438/116).CCLS.	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27

	L #	Hits	Search Text	DBs	Time Stamp
10	L10	2434	(438/612).CCLS.	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27
11	L11	946	(438/723).CCLS.	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27
12	L12	3512	9 or 10 or 11	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27

	L #	Hits	Search Text	DBs	Time Stamp
13	L13	1760	12 and (insulation or insulating or insulated)	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27
14	L14	1360	13 and (opening or via or hole)	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27
15	L15	441	14 and (solder or ball or bump)	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27

	L #	Hits	Search Text	DBs	Time Stamp
16	L16	39	15 and ((glass transparent) near substrate)	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:27
17	L17	33	16 and ((@ad<"20030224") or (@rlad<"20030224"))	US- PGPUB; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	2005/03/28 09:28